

DATE 01 JUL 2008

NOTES:

MOLD CMPD

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- ASME Y14.5M, 1994.
 CONTROLLING DIMENSIONS: MILLIMETERS.
 DIMENSION b APPLIES TO PLATED
 TERMINAL AND IS MEASURED BETWEEN
 0.15 AND 0.30mm FROM TERMINAL TIP.
 COPLANARITY APPLIES TO THE EXPOSED
- PAD AS WELL AS THE TERMINALS.

	MILLIMETERS	
DIM	MIN	MAX
Α	0.80	1.00
A1	0.00	0.05
А3	0.20 REF	
b	0.18	0.30
D	6.00 BSC	
D2	3.10	3.30
E	6.00 BSC	
E2	3.10	3.30
е	0.50 BSC	
K	0.20 MIN	
L	0.30	0.50
L1		0.15

GENERIC **MARKING DIAGRAM***



XXX = Specific Device Code

= Assembly Location

WL = Wafer Lot

YY = Year

WW = Work Week

G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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